Atomic Layer Deposition	ALD in spintronics	STAFF3d-spin o	Summary 00

# Atomic Layer Deposition (ALD) in Magnetism and Spintronics

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Central European Institute of Technology BRNO | CZECH REPUBLIC

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#### Outline of the presentation



#### Atomic Layer Deposition

2 Use of Atomic layer deposition in spintronics





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ALD in spintronic

STAFF3d-spi

#### Atomic Layer Deposition

#### Coating thickness uniformity with different methods



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# Atomic Layer Deposition



- Special mode of Chemical Vapor Deposition (CVD)
- Sequential self-limiting surface chemical reactions
- Conformal coating of rough surfaces, holes, pillars, ...
- Precise control over film thickness (~ 0.1 nm per cycle)

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# Atomic Layer Deposition



- Special mode of Chemical Vapor Deposition (CVD)
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ALD Review: George, *Chem. Rev.* **110**, 111-131 (2010) Various info: www.plasma-ald.com

Conformal coating possible also in a solution – electroless plating

#### What materials can be deposited by ALD?

Close to everything:

- nitrides, oxides [AIO<sub>x</sub>]
- metals, including Fe, Co, Ni, Pt, W, Ta, Ru, Rh, ...
- alloys, ternary and more complex compounds

List of materials: Miikkulainen et al., JAP 113, 021301 (2013)

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# ALD cooking: Recipe and ingredients

ALD deposition - what is needed

- vessel: reactor (rough vacuum, temperature control, gas inlets)
- ingredients: precursors and reactants
- energy: temperature and/or plasma
- **recipe** (process parameters: how much, how long, ...)



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(b) reactants

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ALD cycle – How	it works		



See also https://www.plasma-ald.com/

# ALD in spintronics / magnetism

- [microelectronics]: insulating, protective layers (AlO<sub>x</sub>), conductive seed layers (Cu, Co, Ru)
- spin-Hall-active Pt thin films (order of magnitude worse than sputtered Pt, but detectable & room for improvement) *APL* **112**, 242403 (2018)
- oxide barrier in magnetic tunnel junctions
- magnetic nanotubes

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#### Oxide barrier in magnetic tunnel junctions

Magnetic Tunnel Junction (MTJ): magnet/insulator/magnet Tunneling MagnetoResistance (TMR= $\frac{R_{\uparrow\downarrow}(H)-R_{\uparrow\uparrow}}{R_{\uparrow\uparrow}}$ ) 100s % @ RT

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<u>2D materials</u> (graphene, black P) +  $\leq$  1 nm ALD barrier in MTJs ACS Nano 8(8), 7890-7895 (2014)

#### Magnetic nanotubes deposited using ALD

#### Ni, Co Nanotubes: JAP 111, 09J111 (2007)

Template: pore diameter 35 nm and 160 nm, length 2-50 $\mu$ m Precursor: nickelocene (NiCp2)+H<sub>2</sub>O vapour – gives oxide Reduction better after ALD – Ar+5 % H<sub>2</sub> (lower grain size)



SEM images: TiO<sub>2</sub>/Ni/TiO<sub>2</sub> tubes. Left: in template (top-view), Right: liberated.

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Synthesis and investigation of Synthetic Tubular AntiFerromagnets For 3D Spintronics

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#### Synthesis and investigation of Synthetic Tubular AntiFerromagnets For 3D Spintronics

Goals:

- preparation 3D vertical arrays of tubular SAF (ALD, electroless dep.)
- test of interfaces suitability for spintronics (giant magnetoresistance)
- investigation of individual magnetic nanotubes, tubular SAFs



Synthetic antiferromagnets. (a) current planar structure (Ru  $t \approx 1$  nm) versus proposed 3D vertical structure. (b) Cross-section view on the 3D tubular structure.

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#### Summary: ALD in spintronics/magnetism

- + conformal coating, high-aspect ratio structures (even 1000:1)
- + precise control over thickness, easy for core-shell
- slow, not suitable for thicker coatings ( $\geq$  100 nm)
- typically highly granular
- challenge: high purity, good magnetic properties

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- still mostly oxides (cover layers, barriers in MTJs)
- first tests with Pt for spintronics (spin Hall effect)
- deposition of magnetic nanotubes, but mostly oxides or reduces from oxides (lower quality)
- only few magnetic measurements on ALD magnets (VSM) 11/12

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#### Thank you for your attention!

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